

## APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

<b>Title of Invention</b>	SEMICONDUCTOR PACKAGE FOR MEMORY CHIPS	
Application Type: regular, utility		
Correspondence address:		
<b>Customer Number:</b>	22898	*22898*
Priority Data:		
Doc.No: 092130610; Country - TW; Date: 2003-11-03 us-priority-claimed		
Inventors Information:		
<u>Inventor 1:</u>		
<b>Applicant Authority Type:</b>	Inventor	
<b>Citizenship:</b>	TW	
<b>Given Name:</b>	Cheng-Chian	
<b>Family Name:</b>	Chiang	
<b>City of Residence:</b>	Taichung	
<b>Country of Residence:</b>	TW	
<b>Address-1 of Mailing Address:</b>	No. 123, Sec. 3	
<b>Address-2 of Mailing Address:</b>	Da Fong Road, Tantz	
<b>City of Mailing Address:</b>	Taichung	
<b>State of Mailing Address:</b>		
<b>Postal Code of Mailing Address:</b>		
<b>Country of Mailing Address:</b>	TW	
<b>Phone:</b>		
<b>Fax:</b>		
<b>E-mail:</b>		

Inventor 2:

**Applicant Authority Type:** Inventor  
**Citizenship:** TW  
**Given Name:** Chih-Ming  
**Family Name:** Huang  
**City of Residence:** Taichung  
**Country of Residence:** TW  
**Address-1 of Mailing Address:** No.123, Sec.3  
**Address-2 of Mailing Address:** Da Fong Road, Tantz  
**City of Mailing Address:** Taichung  
**State of Mailing Address:**  
**Postal Code of Mailing Address:**  
**Country of Mailing Address:** TW  
**Phone:**  
**Fax:**  
**E-mail:**

Inventor 3:

**Applicant Authority Type:** Inventor  
**Citizenship:** TW  
**Given Name:** Chin-Huang  
**Family Name:** Chang  
**City of Residence:** Taichung  
**Country of Residence:** TW  
**Address-1 of Mailing Address:** No.123, Sec.3  
**Address-2 of Mailing Address:** Da Fong Road, Tantz  
**City of Mailing Address:** Taichung  
**State of Mailing Address:**  
**Postal Code of Mailing Address:**  
**Country of Mailing Address:** TW  
**Phone:**  
**Fax:**  
**E-mail:**

Inventor 4:

**Applicant Authority Type:** Inventor  
**Citizenship:** TW  
**Given Name:** Cheng-Hsu  
**Family Name:** Hsiao  
**City of Residence:** Taichung  
**Country of Residence:** TW  
**Address-1 of Mailing Address:** No.123, Sec.3  
**Address-2 of Mailing Address:** Da Fong Road, Tantzau  
**City of Mailing Address:** Taichung  
**State of Mailing Address:**  
**Postal Code of Mailing Address:**  
**Country of Mailing Address:** TW  
**Phone:**  
**Fax:**  
**E-mail:**

Inventor 5:

**Applicant Authority Type:** Inventor  
**Citizenship:** TW  
**Given Name:** Min-Nan  
**Family Name:** Tsai  
**City of Residence:** Taichung  
**Country of Residence:** TW  
**Address-1 of Mailing Address:** No.123, Sec.3  
**Address-2 of Mailing Address:** Da Fong Road, Tantzau  
**City of Mailing Address:** Taichung  
**State of Mailing Address:**  
**Postal Code of Mailing Address:**  
**Country of Mailing Address:** TW  
**Phone:**  
**Fax:**  
**E-mail:**

**Attorney Information:**

practitioner(s) at Customer Number:

22898

\*22898\*

as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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**Assignee 1:**

**Organization Name:** SILICONWARE PRECISION INDUSTRIES CO., LTD.

**Address-1 of Mailing Address:** No.123, Sec.3

**Address-2 of Mailing Address:** Da Fong Road, Tantzau

**City of Mailing Address:** Taichung

**State of Mailing Address:**

**Postal Code of Mailing**

**Address:**

**Country of Mailing Address:** TW

**Phone:**

**Fax:**

**E-mail:**